

# TAE雅晶

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| 致T0: |  | 深圳华强聚丰          | 电子科技有限公司                          |   |  |  |  |  |
|------|--|-----------------|-----------------------------------|---|--|--|--|--|
|      | 产品ITEM: 石英晶体谐振器 QUARTZ CRYSTAL UNITS   |                 |                                   |   |  |  |  |  |
|      | 型号TYPE: TDXLF-206 (TXD32.768K2206RDBN-O00S)  |                 |                                   |   |  |  |  |  |
|      | 标称频率NOMINAL FREQUENCY: 32.768KHz 6PF +/-20PPM  |                 |                                   |   |  |  |  |  |
|      | 请收到我们的规格书后,签字回传。 Please confirm you received this specification, sign and fax it to us. 接收确认RECEIVING CONFIRMATION   |                 |                                   |   |  |  |  |  |
|      |  | 日期 <b>D</b> ATA |                                   |   |  |  |  |  |
|      |  | 接收RECEIVED      |                                   |   |  |  |  |  |
|      | 浙江雅晶电子有限公司 ZheJiang ABEL Electron Co.,Ltd. 浙江省台州经济开发区经一路655号 655 JingYi RD. Economic Developing Zone TaiZhou,ZheJi 电话/Tel:0086-576-89025257/89025258/18305768201 传真/Fax:0086-576-88501859 Post Code:318000 URL:www.taecn.com Email: market@taecn.com tae@taecn.com |                 |                                   | ctron Co.,Ltd.<br>\$655号<br>ping Zone TaiZhou,ZheJiang,China<br>25258/18305768201<br>Post Code:318000 |  |  |  |  |
|      |  |                 | 拟制Prepared by:<br>批准Confirmed by: | 应金会<br>王琴飞  |  |  |  |  |

TUNING FORK CRYSTAL UNITS(Cylinder Type) 音叉石英晶體諧振器(柱狀) 浙江雅晶電子股份有限公司

## RoHS Compliant Standard TDXLF-206







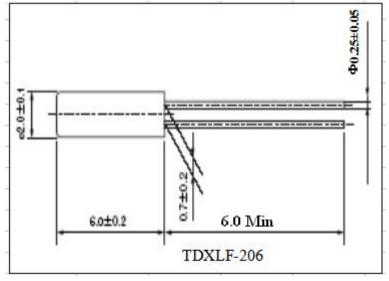
#### Features 特性

- Best suited for portable devices with low current consumption 非常適合低功耗的便攜設備
- For a clock source in digital equipments 適用於數碼設備的所有時鐘源

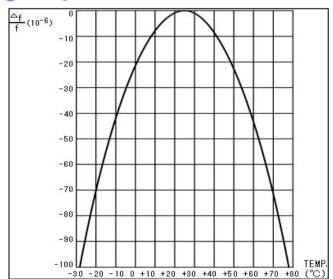
#### ■ STANDARD SPECIFICATIONS 標準規格

| = STANDAND STECHT          | 011110110 | //UTH                                 |                                    |
|----------------------------|-----------|---------------------------------------|------------------------------------|
| Frequency Range            | 頻率範圍      | 32.768KHz                             | Need to specify                    |
| Load Capacitance           | 負載電容      | 6pF                                   | Need to specify                    |
| Drive Level                | 激勵電平      | 1.0µW Max                             |                                    |
| Frequency Tolerance        | 調整頻差      | ±20ppm                                | at 25°C Need to specify            |
| Series Resistance          | 諧振電阻      | 40Kohm Max                            | at 25°C Depend on the frequency    |
| Turnover Temperature       | 拐點溫度      | 25±5℃                                 |                                    |
| Temperature Coefficient    | 二次溫度係數    | $[-0.035\pm0.01]$ ppm/°C <sup>2</sup> |                                    |
| Operating Temperature Rang | e 工作溫度範圍  | -20~+70°C                             |                                    |
| Storage Temperature Range  | 保存溫度範圍    | –40~+85°C                             |                                    |
| Motional Capacitance       | 動態電容      | 0.003pF Typical                       | 和頻率有關Depend on the frequency       |
| Shunt Capacitance          | 靜態電容      | 1.45pF Typical                        | 和頻率有關Depend on the frequency       |
| Capacitance Ratio          | C0/C1     | 500 Typical                           | 和頻率有關Depend on the frequency       |
| Aging[first year]          | 第一年老化率    | ±3ppm Max                             | 25 °C ±3 °C                        |
| Quality Factor             | Q值        | 50000Typical                          | 和頻率有關Depend on the frequency       |
| Insulation Resistance      | 絕緣阻扩      | 500Mohm Min.                          | DC100V±15V(Pin to Pin,Pin to case) |

#### **OUTLINE DIMENSIONS**



#### FREQUENCY VS. TEMPERATURE CURVE



|     |                          |  | Page 1 of 2                              |
|-----|--------------------------|--|--|
| No. | Test Items               | Test Method and Condition  | Requirements                             |
| 1   | 振動                       | (1)振動頻率Vibration Frequency 10 to 55Hz                                | 頻率變化最大:±10ppm                            |
|     | Vibration                | (2)振動幅度Vibration Amplitude 1.5mm                                     | Frequency Change:±10ppm Max.             |
|     |                          | (3)周期 Cycle Time 1-2min(10-55-10Hz)                                  | 電阻變化最大:5kohm                             |
|     |                          | (4)振動方向Direction X.Y.Z   | Resistance Change:5kohm Max.             |
|     |                          | (5)振動時間Duration 2h/each direction                                    |  |
| 2   | 衝擊                       | 從75cm高的地方自由跌落3次到30mm厚的硬木板上   | 頻率變化最大:±10ppm                            |
|     | Shock                    | 3 Times free drop from 75cm height to hard wooden                    | Frequency Change:±10ppm Max.             |
|     |                          | board of thickness more than 30mm                                    | 電阻變化最大:5kohm                             |
|     |                          |  | Resistance Change: 5kohm Max.            |
|     |                          |  |  |
| 3   | 氣密性                      | 晶體放入氦加壓罐內,充入氦氣壓力0.5-0.6Mpa保持1小時;                                     | 漏氣率小於:1x10 <sup>-</sup> 8mbar.l/s        |
|     | Leakage                  | 然後使用氦質譜檢漏儀測試。  | Leakage:1x10 <sup>-</sup> 8mbar.l/s Max. |
|     | Leanage                  | Put crystal units into a hermetic container and Helium for 0.5-0.6   | Dealing Charles on our 15 man.           |
|     |                          | Mpa, and keep it for 1h; Check the leakage by a Helium leak detector |  |
| 4   | 可焊性                      | 將引線浸入完全熔化的焊錫鍋內3-5s,焊錫溫度245℃±5℃                                       |  |
| 7   | Solderability            | Put the leads of crystal units into solder melted tank for 3 to 5s   | 覆蓋The dipped surface of the leads        |
|     | Soluciaulity             | -  | 復  |
|     |                          | Temperature of solder melted tank is 245 °C±5 °C                     |  |
| 5   | <b>壬</b> 丁旭拉哥#           | 350°C±10°C,3+1/-0 sec  | continuous new solder coating            |
| 5   | 手工焊接耐热<br>Soldering iron | 330 C±10 C,3⊤1/-0 sec  | 頻率變化最大:±10ppm                            |
|     | Soldering iron           |  | Frequency Change:±10ppm Max.             |
|     | resistance               |  | 電阻變化最大:10kohm                            |
|     |                          |  | Resistance Change: 10kohm Max.           |
| 6   | 波峰焊耐热                    | 推荐使用下面的波峰焊温度曲线进行波峰焊接。  |  |
|     | Wave soldering           | The WAVE SOLDERING PROFILE as below is recommended:                  |  |
|     | resistance               |  |  |
|     |                          |  |  |
|     |                          |  |  |
|     |                          | 270±5℃ /6\$ Max.   |  |
|     |                          | G  |  |
|     |                          | 260 ========= - 1 1 2ND WAVE   |  |
|     |                          | isima:   |  |
|     |                          | TAN 100 200°C/SEC 200°C/SEC 2°C/SEC 2°C/SEC 2°C/SEC                  |  |
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|     |                          | ≥ 100 2°C/SEC  |  |
|     |                          | 1°C/SEC  |  |
|     |                          | 25   |  |
|     |                          |  |  |
|     |                          | SEC  |  |
|     |                          | TIME (SEC)   |  |
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# 可靠性2Reliability(Mechanical and Environmental Endurance)

### 浙江雅晶電子股份有限公司

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|     |                    |   | Page 2 of 2  |
|-----|--------------------|---|--|
| No. | Test Items         | Test Method and Condition   | Requirements   |
| 6   | 引線強度(引線直插式         | 用0.9kg(9N)的力持續拉晶體引線30s±5s;  | 引線無異常  |
|     | 晶體)                | 用0.45kg的力折引線成90°2次(折弯处离机体1.5mm以上);                                  | The crystal lead is not abnormity                      |
|     | Lead Strength(DIP) | The crystal lead with the 0.9kg(9N)power(keep it for 30s±5s)        |  |
|     |                    | and bend the crystal lead 90° with 0.45kg power and two times       |  |
|     |                    | (which you want to bend should be more than 1.5mm from the          |  |
|     |                    | case)   |  |
| 7   | 耐高溫能力              | 晶體放置於85℃±2℃環境中 2小時後,常溫放置1-2小時                                       | 頻率變化最大:±10ppm  |
|     | High Temperature   | The crystal units shall be put in somewhere for 2 hours at          | Frequency Change:±10ppm Max.                           |
|     | Endurance          | temperature of 85 °C±2 °C, then keep it for 1 to 2 hours under room | 電阻變化最大:5kohm   |
|     |                    | temperature   | Resistance Change:5kohm Max.                           |
|     |                    |   | 不通电工作时,可以满足温度60度,                                      |
| 8   | 耐低溫能力              | 晶體放置於-40℃ 環境中2小時後,常溫放置1-2小時   | 90%湿度,120小时的要求是可以满足                                    |
|     | Low Temperature    | The crystal units shall be put in somewhere for 2 hours at          | 的,通电工作我们没做过测试  |
|     | Endurance          | temperature of -40°C, then keep it for 1 to 2 hours under room      | when with no electrify working, it can be              |
|     |                    | temperature   | satisfied with the cindition of $60^{\circ}\text{C}$ , |
| 9   | 耐濕性                | 晶體放置於40℃、相對濕度90-95%環境中48小時後,常溫放                                     | humidity of 90%, and 120 hours.                        |
|     | Humidity Endurance | 置1-2小時The crystal units shall be put in                             | we don't have a rest with electrify                    |
|     |                    | somewhere at 40°C in relative humidity of 90-95% for 48 hours,      | working  |
|     |                    | then keep it for one or two hours under room temperature            |  |
| 10  | 高低溫迴圈              | 溫度從-40℃(保持30分鐘)升高到100℃(保持30分鐘),再降                                   |  |
|     | Temperature Cycle  | 到-40℃(保持30分鐘)然後回到室溫25℃完成一個迴圈,共計                                     |  |
|     |                    | 5個迴圈Temperature shift from low(-40℃) to high(100℃,keep 30           |  |
|     |                    | minutes),satisfy high(100°C) to low(-40°C,keep 30 minutes),then     |  |
|     |                    | go up to room temperature for 5 cycles                              |  |
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#### 使用說明Processing Instructions

#### 浙江雅晶電子股份有限公司

下面的說明和資訊供用戶正確理解和使用我們公司的石英晶體系列產品 , 預防不當的加工方式對石英晶體的損壞,確保用戶設備的可靠性

The following instructions and information are provided for the purpose of having the user understand the proper way to process our crystal products to prevent problems prior to use and enhance the reliability of the equipment to which they are applied.

#### No. PROCESSING INSTRUCTIONS

#### 1 石英晶體意外跌落When dropped by mistake

設計和製造的石英晶體本身具有耐衝擊能力,但是當石英晶體元件經受劇烈的機械衝擊,如跌落到地板上或安裝期間劇烈震動時,在使用之前需要進行電性能確認

The crystal units are designed and manufactured to resist physical shocks. However, when the crystal units are subjected to excessive impact such as being dropped onto the floor or giving shocks during processing, need to make sure its satisfactory performance before using it.

#### 2 焊接Soldering

#### (1)使用電烙鐵焊接時,引線應該在4秒內焊接完畢,電烙鐵溫度不能高於350℃

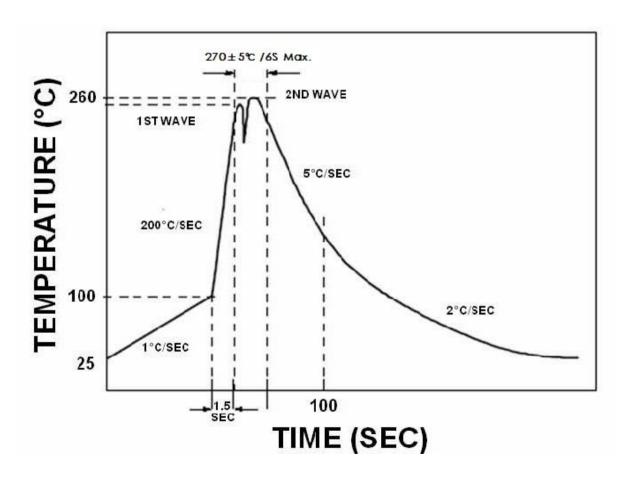
Lead wires should be soldered within 4 seconds with the soldering iron heated to a temperature no higher than 350 °C

**(2)使用浸錫方式焊接時**,引線應該在10秒內焊接完畢,焊錫溫度不能高於260℃,並且注意不能將整個晶體浸錫.推薦使用垂 直安裝方式,避免熱力直接傳導到晶體上

In solder-dip processing, the leads should be soldered within 10 seconds with a temperature no higher than 260°C. Mounting in upright is recommendable to prevent the heat conduction directly to the body of the crystal unit.

#### (3)使用波峰焊接时,请参照下面的波峰焊温度曲线

The WAVE SOLDERING PROFILE as below is recommended for TDXLF-206 tuning fork crystal resonaters.



#### 使用說明Processing Instructions

No.

#### PROCESSING INSTRUCTIONS

#### 3 | 石英晶體彎腳TO BEND THE LEAD of cylinder type products

(1)當圓柱狀晶體元件需要彎腳時,爲了防止彎腳時造成密封玻璃體的破裂,從彎腳處到晶體基座底部距離應大於1.5mm。推 薦距離3.0mm,並使用工裝夾具進行彎腳。

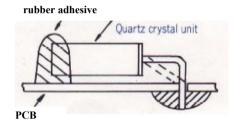
When the lead of cylinder type crystal units need to be bent, leave more than 1.5mm(3.0mm is recommendable) of lead from the case in order to prevent from any cracks of the hermetic sealing glass at the root of the lead, and use a jig to bend if possible. (2)當圓柱狀晶體元件進行彎腳時,不要剝離引線的鍍層

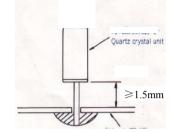
When bending the lead of cylinder type crystal units,do not scrape off the soldering plating from the lead surface.

#### 4 元件的安裝MOUNTING

(1)爲了避免影響元件電性能或損壞元件,嚴禁將圓柱狀晶體元件外殼焊接在印製板上進行固定。推薦使用橡膠粘結劑進行固定Soldering the body of the cylinder type crystal units with PCB must be avoided due to deteriorate the characteristics or damage the products.Rubber adhesive is recommended

Quartz crystal unit





(2)當用手工來彎曲引線時,請遵照下列方法When the lead needs to be bent by hand, please follow the instruction as below: 用手指捏住圓柱晶體的外殼;用鑷子夾住引線要彎曲的部位,該部位離晶體基座底部1.5mm以上(推薦3.0mm); 用鑷子夾住彎曲引線成90°,不要用力拉引線。用力拉引線可能造成引線根部的玻璃子破裂,而產生漏氣損壞元件電性能。 Hold the body of the cylinder type crystal unit in fingers;

Pick at the part with tweezer, which you want to bend. There should be more than 1.5mm(3.0mm is recommended) from the body case; Bend the lead 90° by tweezer without pulling the lead strongly. If pulling the lead strongly may cause any cracks of hermetic sealing glass at the root of the lead and may cause the leakage and the characteristics to deteriorate.

#### 5 石英晶體元件的清洗CLEANING

(1)惡劣的超聲波清洗或超聲波焊接可能會影響和損壞石英晶體元件。如果您對晶體元件進行了超聲波清洗,請一定在使用前確認晶體元件是否受到了影響和損壞

Crystal units may be sffected and destroyed at worst by supersonic cleaning or supersonic welding. Please be sure to check if your cleaning and welding process sffects any damage to crystal units before using.

(2)有些清洗液也可能造成晶體元件的損壞,請在使用清洗液前確認該清洗液是否適用

Some kinds of cleaning fluid may cause any damage to crystal units. Please be sure to check suitability of the cleaning fluid in advance.

#### 6 | 貯存STORAGE

石英晶體元件長時間貯存在高溫或高濕環境中,可能會影響頻率的穩定性或可焊性。請將晶體元件貯存在正常的溫度和濕度 環境中,避免陽光直射和露水凝結,避免貯存6個月以上再使用,拆封後儘快裝配使用。

Storage of crystal units under higher temperature or high humidity for a long term may affects frequency stability or solderability. Please store the crystal units under the normal temperature and humidity without exposing to direct sunlight and dew condensation, and avoid the storage of crystal units for more than 6 months, and mount them as soon as possible after unpacking.